

RD74LVC2G08

Dual 2-Input AND Gate

REJ03D0752-0100 Rev.1.00 Jul 26, 2006

Description

The RD74LVC2G08 has dual 2-input AND gate in an 8-pin package. Low voltage and high-speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

Features

• The basic gate function is lined up as renesas uni logic series.

• Supply voltage range: 1.65 to 5.5 V

• Operating temperature range: -40 to +85°C

• All inputs: V_{IH} (Max.) = 5.5 V (@ V_{CC} = 0 V to 5.5 V)

• All outputs: V_0 (Max.) = 5.5 V (@ V_{CC} = 0 V)

• Output current: $\pm 4 \text{ mA} (@V_{CC} = 1.65 \text{ V})$

 $\pm 8 \text{ mA } (@V_{CC} = 2.3 \text{ V})$

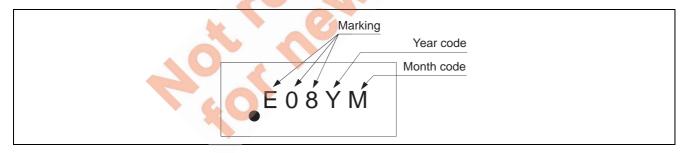
 $\pm 24 \text{ mA } (@V_{CC} = 3.0 \text{ V})$

 $\pm 32 \text{ mA} (@V_{CC} = 4.5 \text{ V})$

• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
RD74LVC2G08WPE	WCSP-8 pin	SXBG0008LA-A (TBS-8BV)	WP	E (3,000 pcs/reel)

Article Indication



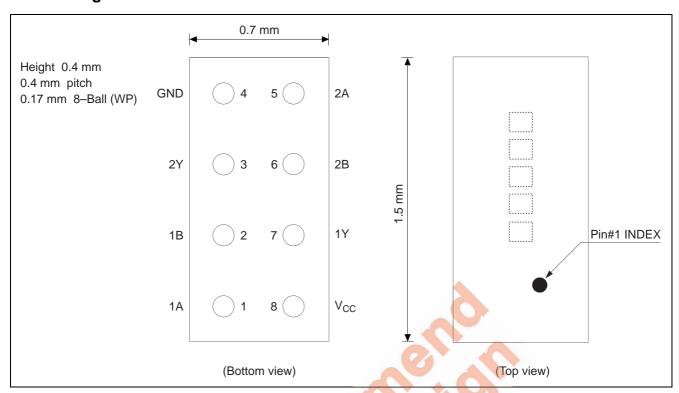
Function Table

Inp	Output Y	
Α	В	Output 1
L	L	L
Н	L	L
L	Н	L
Н	Н	Н

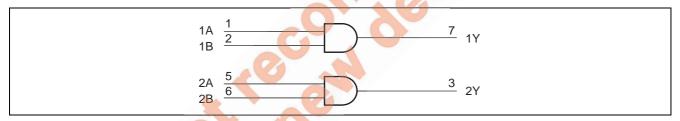
H: High level

L: Low level

Pin Arrangement



Logic Diagram



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	V _{CC}	-0.5 to 6.5	V	
Input voltage range ^{*1}	VI	-0.5 to 6.5	V	
Output voltage range *1, 2	Vo	-0.5 to V _{CC} +0.5	V	Output : H or L
	V _O	-0.5 to 6.5		V _{CC} : OFF
Input clamp current	I _{IK}	-50	mA	V _I < 0
Output clamp current	I _{OK}	-50	mA	V _O < 0
Continuous output current	I ₀	±50	mA	$V_{\rm O} = 0$ to $V_{\rm CC}$
Continuous current through V _{CC} or GND	I _{CC} or I _{GND}	±100	mA	
Package Thermal impedance	θ_{ja}	140	°C/W	WP
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore no two of which may be realized at the same time.

- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.

Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Conditions	
Supply voltage range	V _{CC}	1.65	5.5	V		
Input voltage range	Vı	0	5.5	V		
Output voltage range	Vo	0	V _{CC}	V		
			4		V _{CC} = 1.65 V	
		-	8		V _{CC} = 2.3 V	
	I _{OL}		16		V - 2 0 V	
		-4	24		$V_{CC} = 3.0 \text{ V}$	
Quitout aurrant	40		32	A	V _{CC} = 4.5 V	
Output current	A		-4	mA	V _{CC} = 1.65 V	
			-8		V _{CC} = 2.3 V	
	Іон	<u> </u>	-16		V _{CC} = 3.0 V	
	4	_	-24		V _{CC} = 3.0 V	
		_	-32		V _{CC} = 4.5 V	
		0	20		$V_{CC} = 1.65 \text{ to } 1.95 \text{ V},$	
anut transition rips or fall rate	A+ / A>/	0 2	20	ns / V	2.3 to 2.7 V	
nput transition rise or fall rate	Δt / Δv	0	10	115 / V	$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$	
		0	5		V _{CC} = 4.5 to 5.5 V	
Operating free-air temperature	Ta	-40	85	°C		

Note: Unused or floating inputs must be held high or low.

Electrical Characteristics

 $Ta = -40 \text{ to } 85^{\circ}C$

Item	Symbol	V _{CC} (V)	Min	Тур	Max	Unit	Test condition
	V	1.65 to 1.95	V _{CC} ×0.65	_	_		
		2.3 to 2.7	1.7	_	_		
	V_{IH}	3.0 to 3.6	2.0	_	_		
Innut voltogo		4.5 to 5.5	V _{CC} ×0.7	_	_	V	
Input voltage		1.65 to 1.95	_	_	V _{CC} ×0.35	V	
	W	2.3 to 2.7	_	_	0.7		
	V_{IL}	3.0 to 3.6	_	_	0.8		
		4.5 to 5.5	_	_	V _{CC} ×0.3		
		Min to Max	V _{CC} -0.1	_	_		I _{OH} = -100 μA
		1.65	1.2	_	_		$I_{OH} = -4 \text{ mA}$
	V _{OH}	2.3	1.9	_	_		$I_{OH} = -8 \text{ mA}$
	V ОН	3.0	2.4	_	_		I _{OH} = -16 mA
		3.0	2.3	_	_		$I_{OH} = -24 \text{ mA}$
Output voltage		4.5	3.8	_		V	I _{OH} = −32 mA
Output voltage		Min to Max	_	_	0.1	CO.	I _{OL} = 100 μA
		1.65	_	_	0.45		I _{OL} = 4 mA
	V _{OL}	2.3	_	_	0.3		I _{OL} = 8 mA
	V OL	3.0	_	-/4	0.4		I _{OL} = 16 mA
		3.0	_	-1	0.55		l _{OL} = 24 mA
		4.5	_		0.55		l _{oL} = 32 mA
Input current	I _{IN}	0 to 5.5	_	42	±5	μΑ	V _{IN} = 5.5 V or GND
Quiescent	Icc	1.65 to 5.5	-6		10	^	$V_{IN} = V_{CC}$ or GND, $I_O = 0$
supply current	Δlcc	3 to 5.5	(5)	7	500	μΑ	One input at V _{CC} –0.6 V, Other input at V _{CC} or GND
Output leakage current	l _{OFF}	0	0_	10	±10	μΑ	V_{IN} or $V_O = 0$ to 5.5 V
Input capacitance	C _{IN}	3.3		4	-	pF	V _{IN} = V _{CC} or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

$$V_{CC}=1.8\pm0.15~V$$

Item	Symbol	Ta = -40	$Ta = -40 \text{ to } 85^{\circ}C$		Test Conditions	FROM	ТО
	Symbol	Min	Max	Unit	rest Conditions	(Input)	(Output)
Propagation delay time	t _{PLH} t _{PHL}	2.4	8.0	ns	$C_L = 30 \text{ pF}, R_L = 1.0 \text{ k}\Omega$	A, B	Υ

$$V_{CC}=2.5\pm0.2\ V$$

Item	Symbol	Ta = -40 to 85°C		Unit	Test Conditions	FROM	ТО
	Syllibol	Min	Max	Onne	rest Conditions	(Input)	(Output)
Propagation delay time	t _{PLH} t _{PHL}	1.1	5.5	ns	$C_L = 30 \text{ pF}, R_L = 500 \Omega$	A, B	Υ

$$V_{CC}=3.3\pm0.3\ V$$

Item	Symbol	Symbol $Ta = -40 \text{ to } 85^{\circ}\text{C}$		Unit	Test Conditions	FROM	ТО
	Syllibol	Min	Max	Oilit	rest Conditions	(Input)	(Output)
Propagation delay time	t _{PLH} t _{PHL}	1.0	4.5	ns	$C_L = 50 \text{ pF}, R_L = 500 \Omega$	A, B	Υ

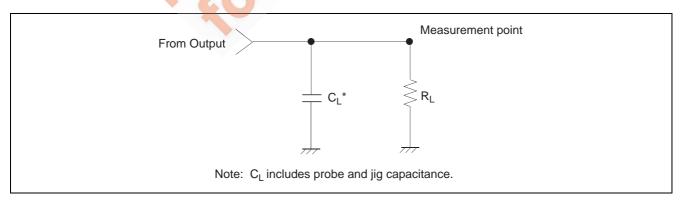
$$V_{CC} = 5.0 \pm 0.5 \text{ V}$$

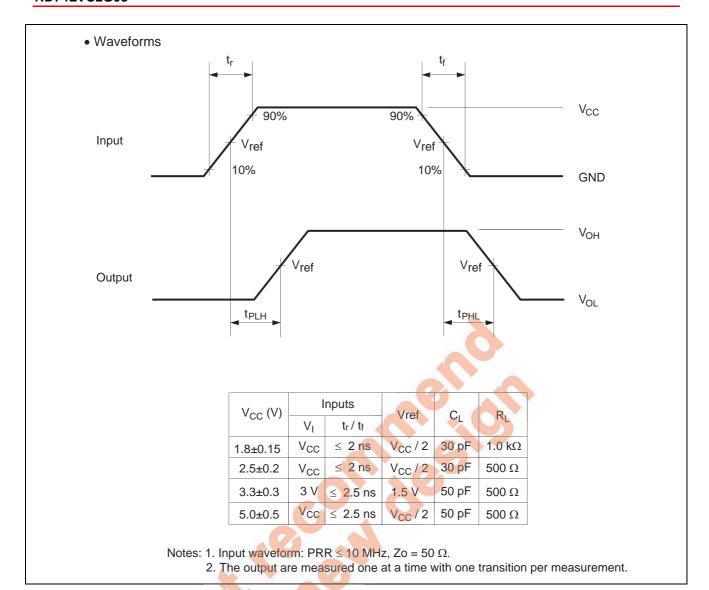
Item	Symbol	Symbol $Ta = -40 \text{ to } 85^{\circ}\text{C}$		Unit	Test Conditions	FROM	ТО
	Syllibol	Min	Max	Onit	rest Collultions	(Input)	(Output)
Propagation delay time	t _{PLH} t _{PHL}	1.0	4.0	ns	$C_L = 50 \text{ pF}, R_L = 500 \ \Omega'$	A, B	Υ

Operating Characteristics

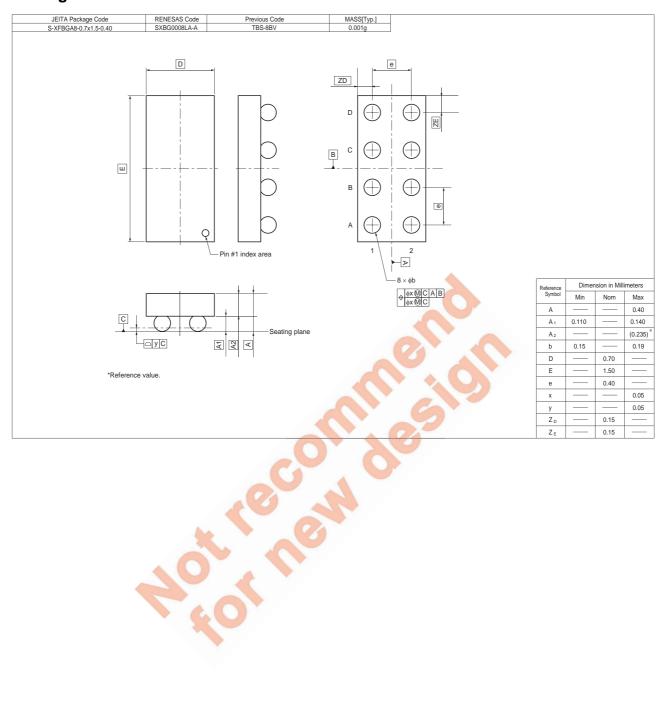
Item	Symbol	V _{CC} (V)		Ta = 25°C		Unit	Test Conditions
item	Symbol	ACC (A)	Min	Тур	Max		rest conditions
Power dissipation capacitance		1.8	211	19	_		
	C _{PD}	2.5	.5 19 — pF	nE	f = 10 MHz		
	CPD	3.3		20	_	- pr	I = IO WINZ
		5.0	—	22	_		

Test Circuit





Package Dimensions



Renesas Technology Corp. Sales Strategic Planning Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

Keep safety first in your circuit designs!

1. Renesas Technology Corp. puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage.

Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or (iii) prevention against any malfunction or mishap.

Notes regarding these materials

1. These materials are intended as a reference to assist our customers in the selection of the Renesas Technology Corp. product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Renesas Technology Corp. or a third party.

2. Renesas Technology Corp. assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials, and are subject to change by Renesas Technology Corp. without notice due to product improvements or other reasons. It is therefore recommended that customers contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor for the latest product information described here may contain technical inaccuracies or typographical errors.

Renesas Technology Corp. assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors. Please also pay attention to information published by Renesas Technology Corp. by various means, including the Renesas Technology Corp. Semiconductor home page (http://www.renesas.com).

4. When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to

- home page (http://www.renesas.com).

 4. When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information and products. Renesas Technology Corp. assumes no responsibility for any damage, liability or other loss resulting from the information contained herein.

 5. Renesas Technology Corp. semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeater use.

use.

6. The prior written approval of Renesas Technology Corp. is necessary to reprint or reproduce in whole or in part these materials.

7. If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination.

Any diversion or reexport contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited.

8. Please contact Renesas Technology Corp. for further details on these materials or the products contained therein.

RENESAS SALES OFFICES

http://www.renesas.com

Refer to "http://www.renesas.com/en/network" for the latest and detailed information.

Renesas Technology America, Inc. 450 Holger Way, San Jose, CA 95134-1368, U.S.A Tel: <1> (408) 382-7500, Fax: <1> (408) 382-7501

Renesas Technology Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K.
Tel: <44> (1628) 585-100, Fax: <44> (1628) 585-900

Renesas Technology (Shanghai) Co., Ltd.
Unit 204, 205, AZIACenter, No.1233 Lujiazui Ring Rd, Pudong District, Shanghai, China 200120 Tel: <86> (21) 5877-1818, Fax: <86> (21) 6887-7898

Renesas Technology Hong Kong Ltd.
7th Floor, North Tower, World Finance Centre, Harbour City, 1 Canton Road, Tsimshatsui, Kowloon, Hong Kong Tel: <852> 2265-6688, Fax: <852> 2730-6071

Renesas Technology Taiwan Co., Ltd.10th Floor, No.99, Fushing North Road, Taipei, Taiwan Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

Renesas Technology Singapore Pte. Ltd.
1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632 Tel: <65> 6213-0200, Fax: <65> 6278-8001

Renesas Technology Korea Co., Ltd. Kukje Center Bldg. 18th Fl., 191, 2-ka, Hangang-ro, Yongsan-ku, Seoul 140-702, Korea Tel: <82> (2) 796-3115, Fax: <82> (2) 796-2145

Renesas Technology Malaysia Sdn. Bhd
Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jalan Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tel: <603> 7955-9390, Fax: <603> 7955-9510

@ 2006 D T T C	A 11 1 1	D' (1' T	_
			1
			1
			1
			1
			-